

RECORDATION FORM COVER SHEET

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

06-01-2000



101371695

Tab settings → → → ▼

To the Honorable Commissioner of F

the attached original documents or copy

1. Name of conveying party(ies):

Chien Ping HUANG

5-19-00

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: January 28, 2000

2. Name and address of receiving party(ies):

Siliconware Precision Industries

Name: Co., Ltd.

Address: No. 123, Sec. 3, Da Fong Road

Tantzu

City: Taichung State/Prov.:

Country: Taiwan, R.O.C. ZIP:

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or registration numbers(s):

09/574,878

If this document is being filed together with a new application, the execution date of the application is: 1/28/00

Patent Application No.

Filing date

B. Patent No.(s)

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Peter F. Corless

Registration No. 33,860

Address: Dike, Bronstein, Roberts & Cushman, LLP

130 Water Street

City: Boston State/Prov.: MA

Country: U.S.A. ZIP: 02109

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

☒ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☐ Authorized to be charged to deposit account

8. Deposit account number:

04-1105

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Peter F. Corless

Name of Person Signing

Signature

Date

3

Total number of pages including cover sheet, attachments, and

PATENT

ASSIGNMENT

WHEREAS, We Chien-Ping HUANG

_____, inventors residing at
(1) No. 8, Lane 26, Kangchuang Street, Chutung Chen, HSinchu Hsien, Taiwan, R.O.C.

hereinafter referred to as "Assignors"), have invented certain new and useful improvements in
" FLASH-FREE MOLD STRUCTURE FOR INTEGRATED CIRCUIT PACKAGE

_____", for which an application for United States
Letters Patent with the same title shall be filed with the United States Patent and Trademark
Office, under application number _____ and a filing date of _____, and

SILICONWARE PRECISION INDUSTRIES
WHEREAS, INDUSTRIES CO., LTD. _____, located at No. 123, Sec. 3, Da Fong Road,
Tantzu, Taichung, Taiwan, R.O.C. _____, (hereinafter referred to as the "Assignee"),
is desirous of acquiring the entire right, title and interest in and to the same invention, and in and
to the said application, and any Letters Patent that may issue thereon;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for
valuable and legally sufficient consideration, the receipt of which is hereby acknowledged, the
Assignors have sold, assigned, and transferred, and do hereby sell, assign and transfer to the
Assignee, its successors and assigns, their entire right, title and interest for the United States in
and to the said invention and in and to the said application and all patents which may be granted
therefor, and all divisions, reissues, substitutions, continuations, in whole or in part, re-
examinations, and extensions thereof, and all applications claiming priority therefrom; and the
Assignors hereby authorize and request the Commissioner of Patents and Trademarks to issue all
patents for said invention, or patents resulting therefrom, insofar as their interest is concerned, to
the Assignee; to have and to hold for the sole and exclusive use and benefit of the Assignee, its
successors and assigns, to the full end of the term or terms for which any and all of said Letters
Patent for said invention may issue, to the same extent as the Assignors would hold and enjoy if
this Assignment had not been made.

The Assignors also have sold, assigned, and transferred, and do hereby sell, assign and
transfer to the Assignee, its successors and assigns, their entire right, title and interest in and to
the invention disclosed in said application, in all countries of the world foreign to the United
States, including the right to file applications and obtain patents for said invention in its own
name in said countries and including all rights of priority in said countries under the terms of any
applicable international convention; to have and to hold for the sole and exclusive use and
benefit of the Assignee, its successors and assigns, to the full end of the term or terms for which
any and all of said Letters Patent for said invention may issue, to the same extent as the
Assignors would hold and enjoy if this Assignment had not been made.

The Assignors also hereby grant the law firm of Dike, Bronstein, Roberts & Cushman LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this documents.

IN WITNESS WHEREOF, the Assignors have caused this Assignment to be executed.

Dated this 20th day of June, ²⁰⁰⁰~~1999~~.

Chien-Ping Huang
Chien-Ping HUANG

Dated this ____ day of _____, 1999.

Dated this ____ day of _____, 1999.

Dated this ____ day of _____, 1999.

Dated this ____ day of _____, 1999.

Dated this ____ day of _____, 1999.